DL PACKAGE

SCAS191C - MARCH 1991 - REVISED APRIL 1998



- Free-Running Read and Write Clocks Can Be Asynchronous or Coincident
- Read and Write Operations Synchronized to Independent System Clocks
- Input-Ready Flag Synchronized to Write Clock
- Output-Ready Flag Synchronized to Read Clock
- 512 Words by 18 Bits
- Low-Power Advanced CMOS Technology
- Half-Full Flag and Programmable Almost-Full/Almost-Empty Flag
- Bidirectional Configuration and Width Expansion Without Additional Logic
- Fast Access Times of 12 ns With a 50-pF Load and All Data Outputs Switching Simultaneously
- Data Rates up to 67 MHz
- Pin-to-Pin Compatible With SN74ACT7805 and SN74ACT7813
- Packaged in Shrink Small-Outline 300-mil Package Using 25-mil Center-to-Center Spacing

#### description

The SN74ACT7803 is a 512-word × 18-bit FIFO suited for buffering asynchronous datapaths up to

67-MHz clock rates and 12-ns access times. Two devices can be configured for bidirectional data buffering without additional logic. Multiple distributed  $V_{CC}$  and GND pins, along with Texas Instruments patented output edge control ( $OEC^{TM}$ ) circuit, dampen simultaneous switching noise.

The write clock (WRTCLK) and read clock (RDCLK) are free running and can be asynchronous or coincident. Data is written to memory on the rising edge of WRTCLK when WRTEN1 is high,  $\overline{WRTEN2}$  is low, and input ready (IR) is high. Data is read from memory on the rising edge of RDCLK when  $\overline{RDEN}$ ,  $\overline{OE1}$ , and  $\overline{OE2}$  are low and output ready (OR) is high. The first word written to memory is clocked through to the output buffer, regardless of the  $\overline{RDEN}$ ,  $\overline{OE1}$ , and  $\overline{OE2}$  levels. The OR flag indicates that valid data is present on the output buffer.

The FIFO can be reset asynchronously to WRTCLK and RDCLK. RESET must be asserted while at least four WRTCLK and four RDCLK rising edges occur to clear the synchronizing registers. Resetting the FIFO initializes the IR, OR, and half-full (HF) flags low and the almost-full/almost-empty (AF/AE) flag high. The FIFO must be reset upon power up.

The SN74ACT7803 is characterized for operation from 0°C to 70°C.

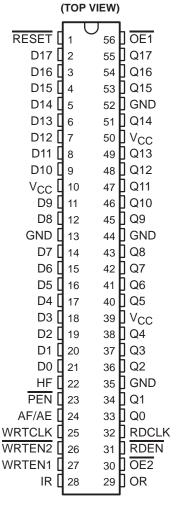


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of TexasInstruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus and OEC are trademarks of Texas Instruments Incorporated.

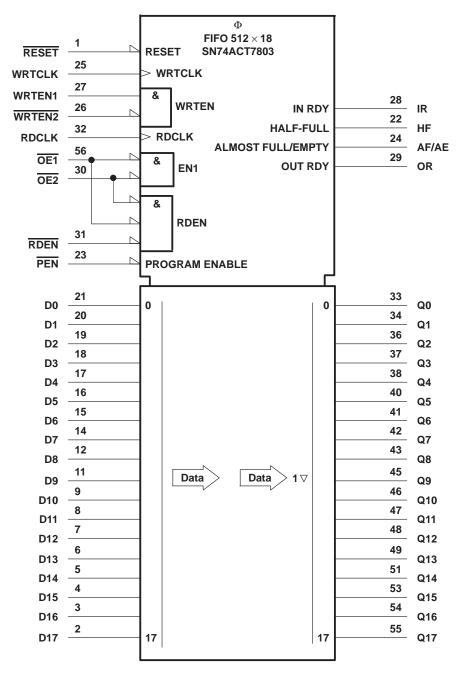
TEXAS INSTRUMENTS

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265



Copyright © 1998, Texas Instruments Incorporated

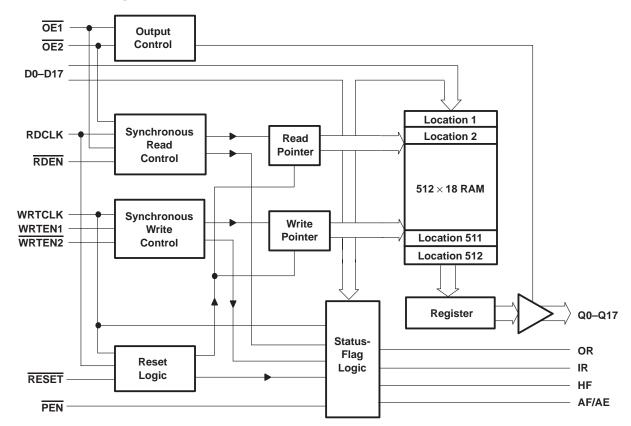
## logic symbol†



<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



## functional block diagram



## **Terminal Functions**

| TEI              | RMINAL                                      |     | DECODINE   |
|------------------|---|-----|--|
| NAME             | NO.   | 1/0 | DESCRIPTION  |
| AF/AE            | 24  | 0   | Almost-full/almost-empty flag. Depth-offset values can be programmed for AF/AE, or the default value of 64 can be used for both the almost-empty offset (X) and the almost-full offset (Y). AF/AE is high when memory contains X or fewer words or (512 – Y) or more words. AF/AE is high after reset.                     |
| D0-D17           | 2–9, 11–12,<br>14–21                        | ı   | 18-bit data input port   |
| HF               | 22  | 0   | Half-full flag. HF is high when the FIFO memory contains 256 or more words. HF is low after reset.   |
| IR               | 28  | 0   | Input-ready flag. IR is synchronized to the low-to-high transition of WRTCLK. When IR is low, the FIFO is full and writes are disabled. IR is low during reset and goes high on the second low-to-high transition of WRTCLK after reset.   |
| OE1<br>OE2       | 56<br>30                                    | ı   | Output enables. When OE1, OE2, and RDEN are low and OR is high, data is read from the FIFO on a low-to-high transition of RDCLK. When either OE1 or OE2 is high, reads are disabled and the data outputs are in the high-impedance state.  |
| OR               | 29  | 0   | Output-ready flag. OR is synchronized to the low-to-high transition of RDCLK. When OR is low, the FIFO is empty and reads are disabled. Ready data is present on Q0–Q17 when OR is high. OR is low during reset and goes high on the third low-to-high transition of RDCLK after the first word is loaded to empty memory. |
| PEN              | 23  | ı   | Program enable. After reset and before the first word is written to the FIFO, the binary value on D0–D7 is latched as an AF/AE offset value when PEN is low and WRTCLK is high.  |
| Q0-Q17           | 33–34, 36–38,<br>40–43, 45–49,<br>51, 53–55 | 0   | 18-bit data output port. After the first valid write to empty memory, the first word is output on Q0–Q17 on the third rising edge of RDCLK. OR also is asserted high at this time to indicate ready data. When OR is low, the last word read from the FIFO is present on Q0–Q17.   |
| RDCLK            | 32  | ı   | Read clock. RDCLK is a continuous clock and can be asynchronous or coincident to WRTCLK. A low-to-high transition of RDCLK reads data from memory when $\overline{OE1}$ , $\overline{OE2}$ , and $\overline{RDEN}$ are low and OR is high. OR is synchronous to the low-to-high transition of RDCLK.                       |
| RDEN             | 31  | ı   | Read enable. When RDEN, OE1, and OE2 are low and OR is high, data is read from the FIFO on the low-to-high transition of RDCLK.  |
| RESET            | 1   | I   | Reset. To reset the FIFO, four low-to-high transitions of RDCLK and four low-to-high transitions of WRTCLK must occur while RESET is low. This sets HF, IR, and OR low and AF/AE high.   |
| WRTCLK           | 25  | I   | Write clock. WRTCLK is a continuous clock and can be asynchronous or coincident to RDCLK. A low-to-high transition of WRTCLK writes data to memory when WRTEN2 is low, WRTEN1 is high, and IR is high. IR is synchronous to the low-to-high transition of WRTCLK.  |
| WRTEN1<br>WRTEN2 | 27<br>26                                    | I   | Write enables. When WRTEN1 is high, WRTEN2 is low, and IR is high, data is written to the FIFO on a low-to-high transition of WRTCLK.  |



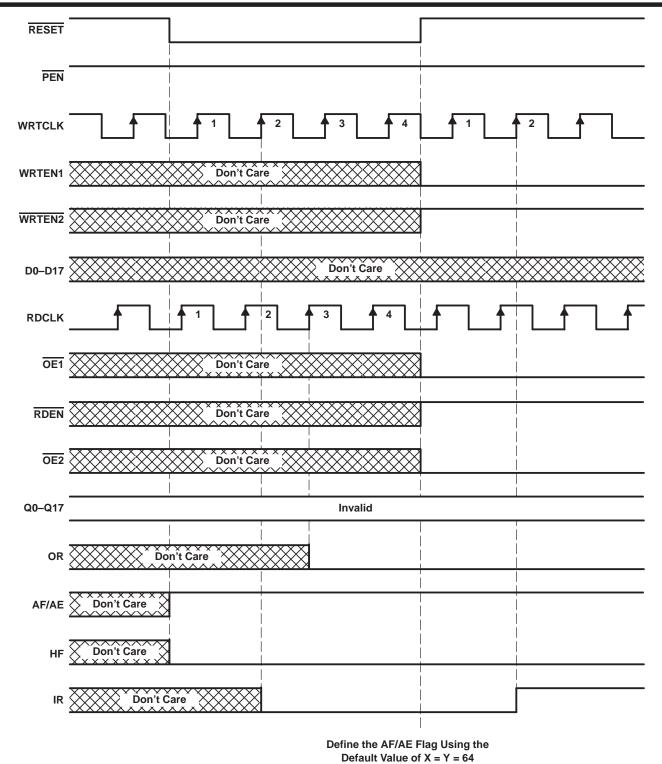


Figure 1. Reset Cycle



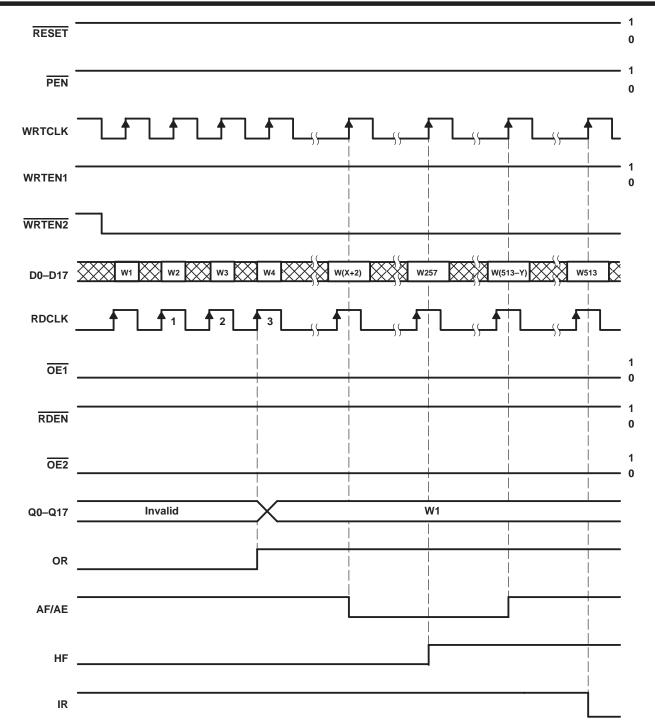


Figure 2. Write Cycle



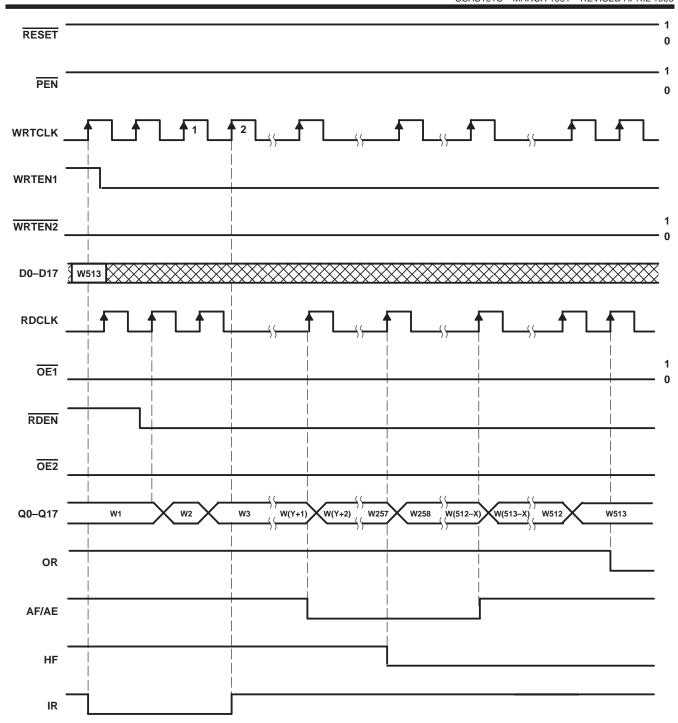


Figure 3. Read Cycle



#### offset values for AF/AE

The AF/AE flag has two programmable limits: the almost-empty offset value (X) and the almost-full offset value (Y). They can be programmed after the FIFO is reset and before the first word is written to memory. If the offsets are not programmed, the default values of X = Y = 64 are used. The AF/AE flag is high when the FIFO contains X or fewer words or (512 – Y) or more words.

Program enable (PEN) should be held high throughout the reset cycle. PEN can be brought low only when IR is high and WRTCLK is low. On the following low-to-high transition of WRTCLK, the binary value on D0-D7 is stored as the almost-empty offset value (X) and the almost-full offset value (Y). Holding PEN low for another low-to-high transition of WRTCLK reprograms Y to the binary value on D0-D7 at the time of the second WRTCLK low-to-high transition. When the offsets are being programmed, writes to the FIFO memory are disabled, regardless of the state of the write enables (WRTEN1, WRTEN2). A maximum value of 255 can be programmed for either X or Y (see Figure 4). To use the default values of X = Y = 64,  $\overline{PEN}$  must be held high.

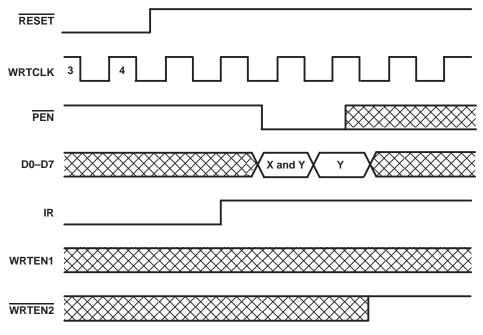


Figure 4. Programming X and Y Separately

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage range, V <sub>CC</sub>                   | $\dots$ –0.5 V to 7 V                            |
|---|--|
| Input voltage range, V <sub>1</sub>                     | $\dots$ –0.5 V to 7 V                            |
| Voltage range applied to a disabled 3-state output      | 5.5 V  |
| Package thermal impedance, θ <sub>JA</sub> (see Note 1) | 74°C/W   |
| Storage temperature range, T <sub>stg</sub>             | . $-65^{\circ}\text{C}$ to $150^{\circ}\text{C}$ |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51.



## recommended operating conditions

|                                |                                |                  | 'ACT78 | 303-15 | 'ACT78 | 303-20 | 'ACT78 | 303-25 | 'ACT78 | 303-40 | UNIT |  |
|--------------------------------|--------------------------------|------------------|--------|--------|--------|--------|--------|--------|--------|--------|------|--|
|                                |                                |                  | MIN    | MAX    | MIN    | MAX    | MIN    | MAX    | MIN    | MAX    | UNIT |  |
| V <sub>CC</sub> Supply voltage |                                |                  | 4.5    | 5.5    | 4.5    | 5.5    | 4.5    | 5.5    | 4.5    | 5.5    | V    |  |
| VIH                            | High-level input voltage       |                  |        |        | 2      |        | 2      |        | 2      |        | V    |  |
| VIL                            | Low-level input voltage        |                  |        | 0.8    |        | 0.8    |        | 0.8    |        | 0.8    | V    |  |
| ІОН                            | High-level output current      | Q outputs, flags |        | -8     |        | -8     |        | -8     |        | -8     | mA   |  |
| la.                            | Low-level output current       | Q outputs        |        | 16     |        | 16     |        | 16     |        | 16     | mA   |  |
| lol                            | Low-level output current       | Flags            |        | 8      |        | 8      |        | 8      |        | 8      |      |  |
| TA                             | Operating free-air temperature |                  | 0      | 70     | 0      | 70     | 0      | 70     | 0      | 70     | °C   |  |

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PA                 | PARAMETER TEST CONDITIONS |                              |                          |  |     | TYP <sup>†</sup> | MAX | UNIT |
|--------------------|---------------------------|------------------------------|--------------------------|--|-----|------------------|-----|------|
| Vон                |                           | $V_{CC} = 4.5 \text{ V},$    | $I_{OH} = -8 \text{ mA}$ |  | 2.4 |                  |     | V    |
| Vai                | Flags                     | $V_{CC} = 4.5 \text{ V},$    | $I_{OL} = 8 \text{ mA}$  |  |     |                  | 0.5 | V    |
| VOL                | Q outputs                 | $V_{CC} = 4.5 \text{ V},$    | $I_{OL} = 16 \text{ mA}$ |  |     |                  | 0.5 | ٧    |
| Ц                  |                           | $V_{CC} = 5.5 \text{ V},$    | $V_I = V_{CC}$ or 0      |  |     |                  | ±5  | μΑ   |
| loz                |                           | $V_{CC} = 5.5 \text{ V},$    | VO = VCC or 0            |  |     |                  | ±5  | μΑ   |
| Icc                |                           | $V_{I} = V_{CC} - 0.2 V_{C}$ | or 0                     |  |     |                  | 400 | μΑ   |
| ∆l <sub>CC</sub> ‡ |                           | $V_{CC} = 5.5 \text{ V},$    | One input at 3.4 V,      | Other inputs at V <sub>CC</sub> or GND |     |                  | 1   | mA   |
| Ci                 |                           | $V_{ } = 0,$                 | f = 1 MHz                |  |     | 4                |     | pF   |
| Co                 |                           | $V_{O} = 0$ ,                | f = 1 MHz                |  |     | 8                |     | pF   |

<sup>†</sup> All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C. ‡ This is the supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or  $V_{CC}$ .

## timing requirements over recommended operating conditions (see Figures 1 through 5)

|                 |                 |   | 'ACT78 | 303-15 | 'ACT78 | 303-20 | 'ACT78 | 303-25 | 'ACT78 | 03-40 | UNIT |  |
|-----------------|-----------------|---|--------|--------|--------|--------|--------|--------|--------|-------|------|--|
|                 |                 |   | MIN    | MAX    | MIN    | MAX    | MIN    | MAX    | MIN    | MAX   | UNIT |  |
| fclock          | Clock frequency |   |        | 67     |        | 50     |        | 40     |        | 25    | MHz  |  |
|                 |                 | WRTCLK high or low                                | 6      |        | 7      |        | 8      |        | 12     |       |      |  |
| t <sub>W</sub>  | Pulse duration  | RDCLK high or low                                 | 6      |        | 7      |        | 8      |        | 12     |       | ns   |  |
|                 |                 | PEN low   | 8      |        | 9      |        | 9      |        | 12     |       |      |  |
|                 |                 | D0-D17 before WRTCLK↑                             | 4      |        | 5      |        | 5      |        | 5      |       |      |  |
|                 |                 | WRTEN1, WRTEN2<br>before WRTCLK↑                  |        |        | 5      |        | 5      |        | 5      |       |      |  |
|                 | Cotup time      | OE1, OE2 before RDCLK↑                            | 5      |        | 5      | 5 6    |        |        | 6      |       | ns   |  |
| t <sub>su</sub> | Setup time      | RDEN before RDCLK↑                                | 4      |        | 5      |        | 5      |        | 5      |       | ns   |  |
|                 |                 | Reset: RESET low before first WRTCLK↑ and RDCLK↑† |        |        | 6      |        | 6      |        | 6      |       |      |  |
|                 |                 | PEN before WRTCLK↑                                | 5      |        | 6      |        | 6      |        | 6      |       |      |  |
|                 |                 | D0-D17 after WRTCLK↑                              | 0      |        | 0      |        | 0      |        | 0      |       |      |  |
|                 |                 | WRTEN1, WRTEN2 after WRTCLK↑                      | 0      |        | 0      |        | 0      |        | 0      |       |      |  |
| ۱.              | Hold time       | OE1, OE2, RDEN after RDCLK↑                       | 0      |        | 0      |        | 0      |        | 0      |       |      |  |
| t <sub>h</sub>  | noia time       | Reset: RESET low after fourth WRTCLK↑ and RDCLK↑  | 2      |        | 2      |        | 2      |        | 2      |       | ns   |  |
|                 |                 | PEN high after WRTCLK↓                            | 0      |        | 0      |        | 0      |        | 0      |       |      |  |
|                 |                 | PEN low after WRTCLK↑                             | 2      |        | 2      |        | 2      |        | 2      |       |      |  |

<sup>&</sup>lt;sup>†</sup> To permit the clock pulse to be utilized for reset purposes

# switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L$ = 50 pF (unless otherwise noted) (see Figure 5)

|                   | FROM               | то       | 'A  | CT7803-1 | 15   | 'ACT78 | 303-20 | 'ACT7803-25 |     | 'ACT7803-40 |     |      |
|-------------------|--------------------|----------|-----|----------|------|--------|--------|-------------|-----|-------------|-----|------|
| PARAMETER         | (INPUT)            | (OUTPUT) | MIN | TYP†     | MAX  | MIN    | MAX    | MIN         | MAX | MIN         | MAX | UNIT |
| f <sub>max</sub>  | WRTCLK or<br>RDCLK |          | 67  |          |      | 50     |        | 40          |     | 25          |     | MHz  |
| <sup>t</sup> pd   | RDCLK↑             | Any Q    | 4   | 9.5      | 12   | 4      | 13     | 4           | 15  | 4           | 20  | ns   |
| t <sub>pd</sub> ‡ | RDCLK↑             | Any Q    |     | 8.5      |      |        |        |             |     |             |     | ns   |
|                   | WRTCLK↑            | IR       | 3   |          | 8.5  | 3      | 11     | 3           | 13  | 3           | 15  |      |
|                   | RDCLK↑             | OR       | 3   |          | 8.5  | 3      | 11     | 3           | 13  | 3           | 15  |      |
| <sup>t</sup> pd   | WRTCLK↑            | AF/AE    | 7   |          | 16.5 | 7      | 19     | 7           | 21  | 7           | 23  | ns   |
|                   | RDCLK↑             | AF/AE    | 7   |          | 17   | 7      | 19     | 7           | 21  | 7           | 23  |      |
| t <sub>PLH</sub>  | WRTCLK↑            | HF       | 7   |          | 15   | 7      | 17     | 7           | 19  | 7           | 21  | ns   |
| t <sub>PHL</sub>  | RDCLK↑             | HF       | 7   |          | 15.5 | 7      | 18     | 7           | 20  | 7           | 22  | ns   |
| <sup>t</sup> PLH  | RESET low          | AF/AE    | 2   |          | 9    | 2      | 11     | 2           | 13  | 2           | 15  | ns   |
| t <sub>PHL</sub>  | RESET low          | HF       | 2   |          | 10   | 2      | 12     | 2           | 14  | 2           | 16  | ns   |
| <sup>t</sup> en   | OE1, OE2           | Any Q    | 2   |          | 8.5  | 2      | 11     | 2           | 11  | 2           | 11  | ns   |
| <sup>t</sup> dis  | OE1, OE2           | Any Q    | 2   |          | 9.5  | 2      | 11     | 2           | 14  | 2           | 14  | ns   |

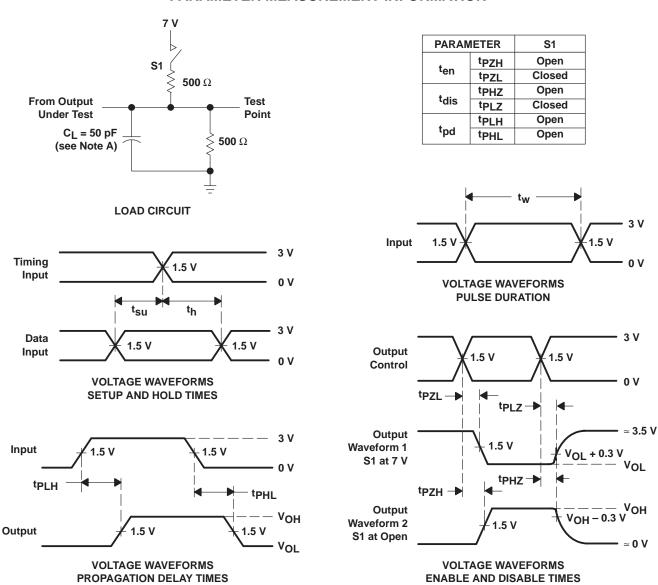
<sup>&</sup>lt;sup>‡</sup> This parameter is measured with a 30-pF load (see Figure 6).



# operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

|                 | PARAMETER                     | TEST CO         | TYP                     | UNIT      |    |    |
|-----------------|-------------------------------|-----------------|-------------------------|-----------|----|----|
| C <sub>pd</sub> | Power dissipation capacitance | Outputs enabled | C <sub>L</sub> = 50 pF, | f = 5 MHz | 53 | pF |

#### PARAMETER MEASUREMENT INFORMATION

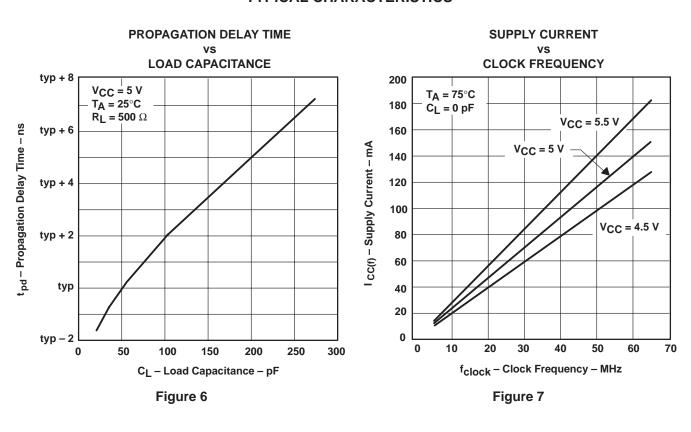


NOTE A:  $C_L$  includes probe and jig capacitance.

Figure 5. Load Circuit and Voltage Waveforms



#### TYPICAL CHARACTERISTICS



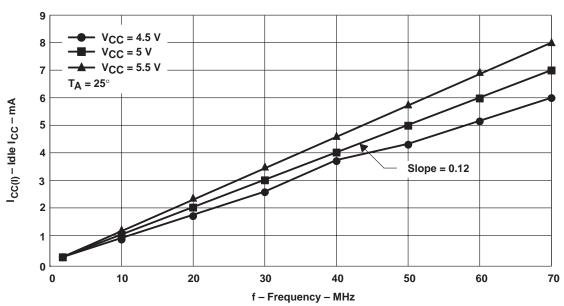


Figure 8. SN74ACT7803 Idle I<sub>CC</sub> With RDCLK or WRTCLK Switching



#### **APPLICATION INFORMATION**

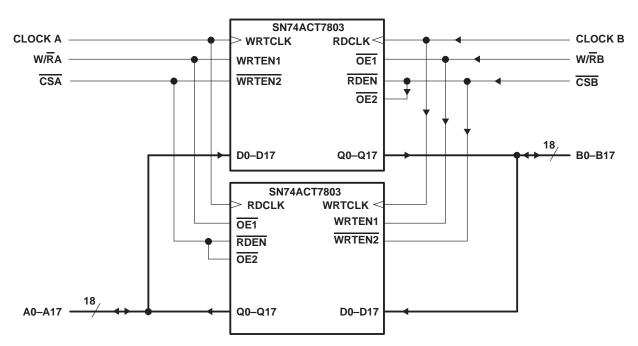


Figure 9. Bidirectional Configuration

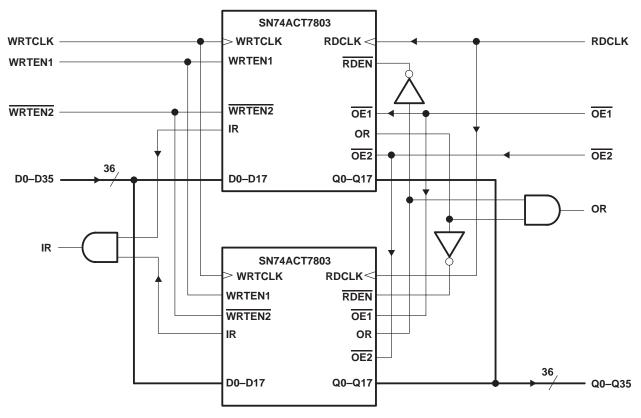


Figure 10. Word-Width Expansion: 512 × 36 Bits



www.ti.com 11-Nov-2025

#### PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type | Package   Pins | Package qty   Carrier | RoHS | Lead finish/<br>Ball material | MSL rating/<br>Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|------------|---------------|----------------|-----------------------|------|-------------------------------|----------------------------|--------------|------------------|
| SN74ACT7803-15DL      | Active     | Production    | SSOP (DL)   56 | 20   TUBE             | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | 0 to 70      | ACT7803-15       |
| SN74ACT7803-15DL.A    | Active     | Production    | SSOP (DL)   56 | 20   TUBE             | Yes  | NIPDAU                        | Level-1-260C-UNLIM         | 0 to 70      | ACT7803-15       |

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

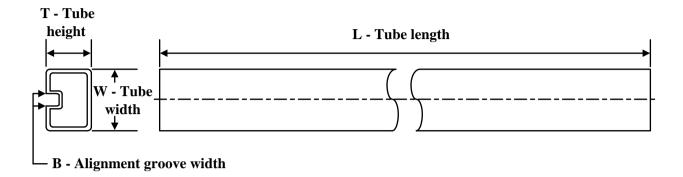
<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 23-May-2025

### **TUBE**

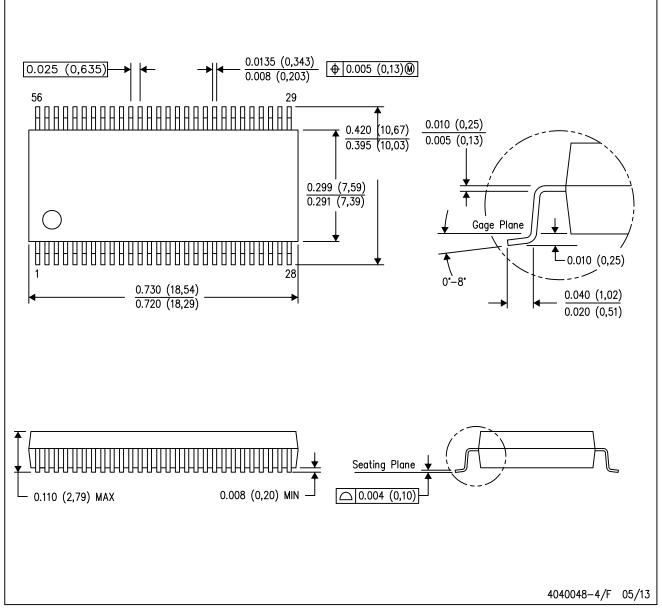


#### \*All dimensions are nominal

| Device             | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|--------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74ACT7803-15DL   | DL           | SSOP         | 56   | 20  | 473.7  | 14.24  | 5110   | 7.87   |
| SN74ACT7803-15DL.A | DL           | SSOP         | 56   | 20  | 473.7  | 14.24  | 5110   | 7.87   |

# DL (R-PDSO-G56)

# PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

PowerPAD is a trademark of Texas Instruments.



#### IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale, TI's General Quality Guidelines, or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2025, Texas Instruments Incorporated

Last updated 10/2025